**New Product** 



SiJ484DP

RoHS

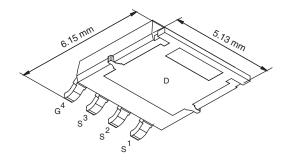
COMPLIANT

Vishay Siliconix

## N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a, g</sup>	Q <sub>g</sub> (Typ.)		
30	0.0063 at V <sub>GS</sub> = 10 V	35 <sup>g</sup>	13.7 nC		
	0.0082 at $V_{GS}$ = 4.5 V	35 <sup>g</sup>	13.7 110		



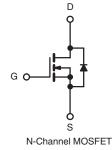


#### FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- DC/DC
  - High-Side Switch



Ordering Information: SiJ484DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$	I <sub>D</sub>	35 <sup>9</sup> 35 <sup>9</sup> 21.5 <sup>b, c</sup> 17.2 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	70	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	I <sub>S</sub>	35 <sup>g</sup> 4.5 <sup>b, c</sup>	$\neg$	
Single Pulse Avalanche Current	L _ 0.1 mH	I <sub>AS</sub>	20		
Single Pulse Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	20	mJ	
Maximum Power Dissipation	$T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$	P <sub>D</sub>	27.7 17.7 5.0 <sup>b, c</sup>	w	
$T_{A} = 70 \text{ °C}$ Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	<u>3.2<sup>b, c</sup></u> - 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	3.4	4.5		

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 70 °C/W.

g. Package limited.

d. See Solder Profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 250 uA		30		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.0			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
		$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 V, V_{GS} = 10 V$	30			А	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.0052	0.0063	Ω	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 7 \text{ A}$		0.0067	0.0082		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A		50		S	
Dynamic <sup>b</sup>						1	
Input Capacitance	C <sub>iss</sub>			1600			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		335		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			115			
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		30	45	- nC	
				13.7	21		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		4.3			
Gate-Drain Charge	Q <sub>gd</sub>			4.3			
Gate Resistance	Rg	f = 1 MHz	0.3	0.75	1.5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			13	26		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		9	18	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 10 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		22	40		
Fall Time	t <sub>f</sub>			8	16		
Turn-On Delay Time	t <sub>d(on)</sub>			22	40		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		13	26		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 $\Omega$		26	50		
Fall Time	t <sub>f</sub>			12	24		
Drain-Source Body Diode Characteristic	cs			1	1	1	
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			35	•	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.75	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			19	35	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 10.0  d/dt = 100.044  s = 00.90		9.5	18	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		11			
Reverse Recovery Rise Time	t <sub>b</sub>	—		8		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

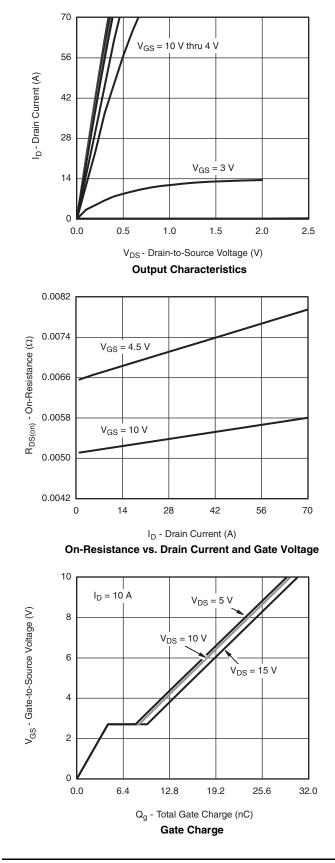
b. Guaranteed by design, not subject to production testing.

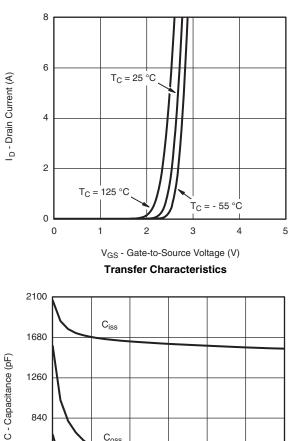
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





840

420

0

0

 $C_{rss}$ 

5

Coss

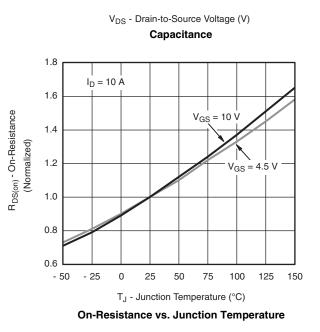
10

15

20

25

30

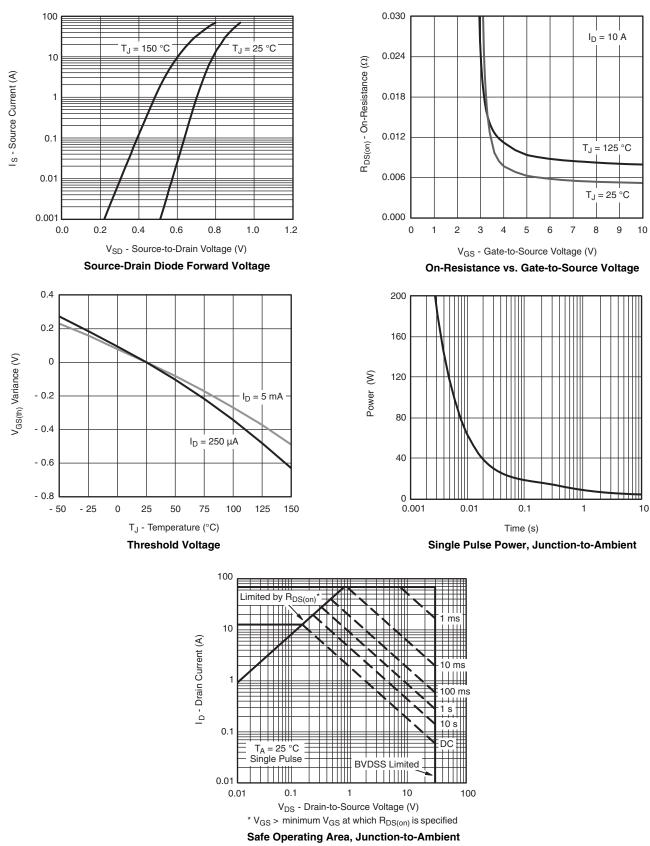


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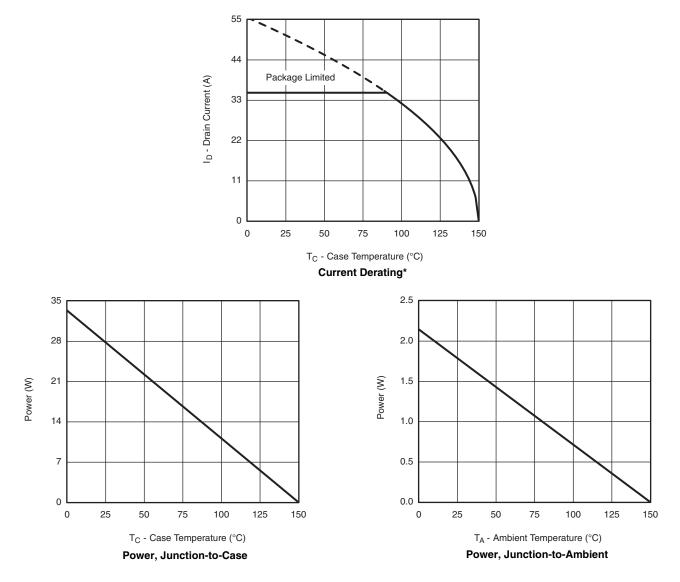
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## SiJ484DP Vishay Siliconix

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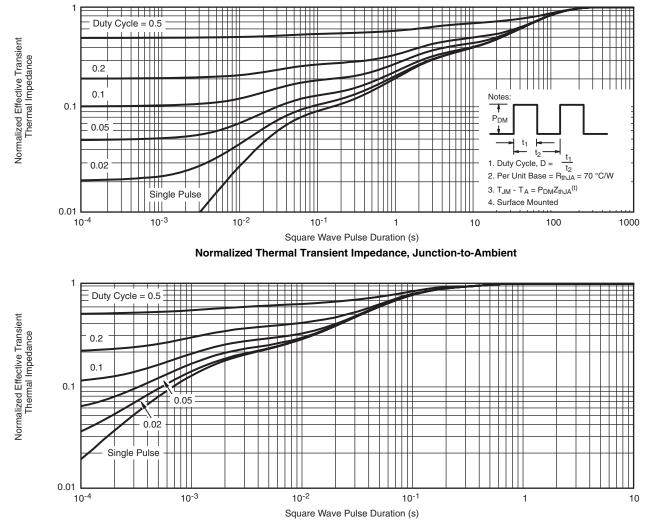


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg264812">www.vishay.com/ppg264812</a>.



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